

MSKSEMI

SEMICONDUCTOR



ESD



TVS



TSS



MOV



GDT



PLED

Product data sheet

www.msksemi.com

FEATURES

- Low forward voltage
- High current capability
- High forward surge capability
- Low power losses, High efficiency
- Guarding for over voltage protection

APPLICATIONS

Low VF Schottky barrier rectifier are designed for high frequency, miniature switched mode power supplies such as adapters ,lighting and on-board DC/DC conerters

Primary Characteristic	
I_O	2*10A
V_{RRM}	100V
I_{FSM}	250A
V_F	0.68V
T_{Jmax}	150°C
Assembly code	AL

MECHANICAL DATA

- **Case:** Molded plastic
- **Polarity:** As marked
- **Mounting Position:** Any
- **Molded Plastic:** UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106

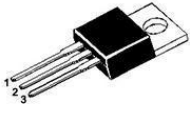
Maximum Ratings (Per Leg) at Ta=25°C unless otherwise specified			
Characteristics	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Working Peak Reverse Voltage	V_{RWM}	100	V
Maximum DC Blocking Voltage	V_{DC}	100	V
Maximum Average Forward Rectified Current	I_O	Per Leg	10
		Total	20
Peak Forward Surge Current,8.3 ms Single Half Sine-wave	I_{FSM}	250	A
Operating Temperature Range	T_J	150	°C
Storage Temperature Range	T_{STG}	-40 to +150	°C
Typical Thermal Resistance(Note1)	$R_{\theta JC}$	2	°C/W
TO-220AB,TO-263,TO-252			
TO-220F			

Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

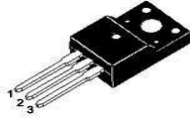
Electrical Characteristics (Per Leg) unless otherwise specified					
Characteristics		Symbol	Value		Unit
Forward Voltage Drop(Note2)		V_F	Typ.	Max.	V
at $I_F=3A$	TA=25°C		0.69	-	
	TA=125°C		0.60	-	
at $I_F=5A$	TA=25°C		0.74	-	
	TA=125°C		0.61	-	
at $I_F=10A$	TA=25°C		0.82	0.85	
	TA=125°C		0.68	-	
Maximum Reverse Current at $V_R=100V$	TA=25°C		I_R	1.5	
	TA=125°C		1	-	mA

Note2:Pulse test: 300 µs pulse width, 1 % duty cycle

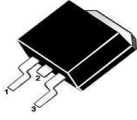
SCHOTTKY BARRIER RECTIFIER



TO-220AB/CT



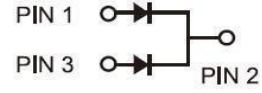
TO-220F/FCT



TO-263/DC

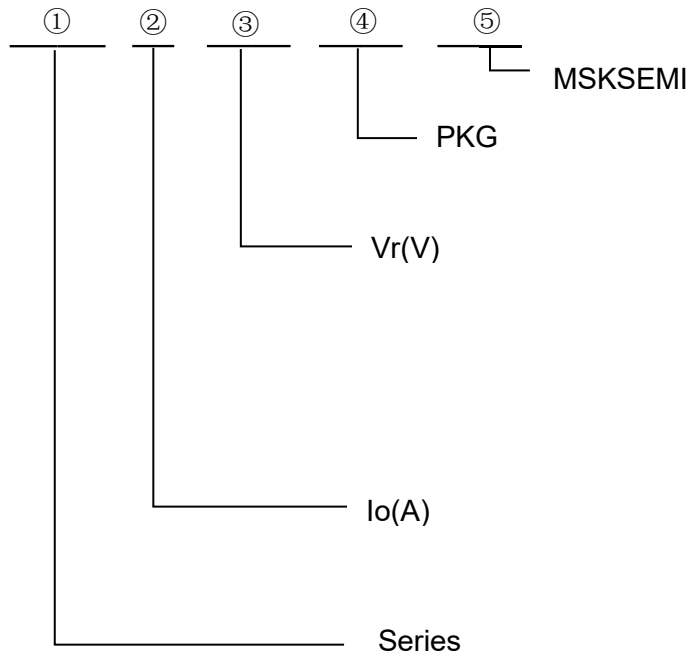


TO-252/CS



P/N Information

MBR 20 100 XXX -MS



①	②	③	④	⑤
系列	平均整流电流	直流反向耐压	封装	MSKSEMI

RATINGS AND CHARACTERISTIC CURVES

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

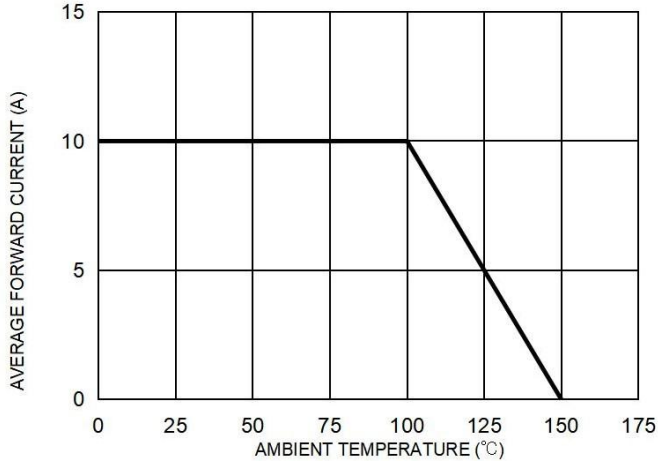


FIG. 2 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

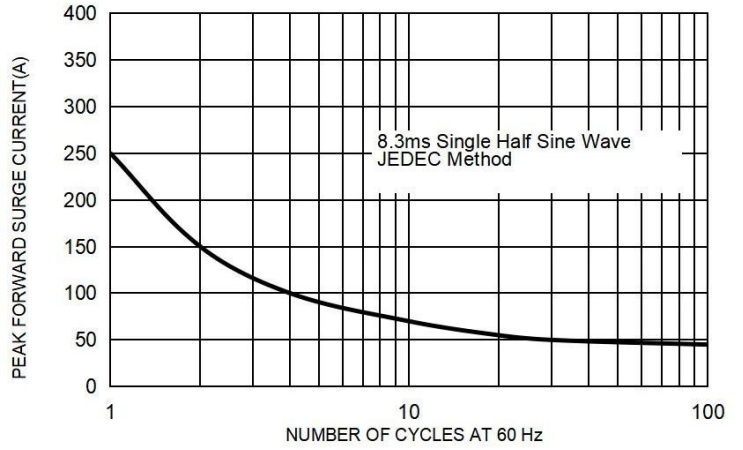


FIG. 3 TYPICAL FORWARD CHARACTERISTICS PER LEG

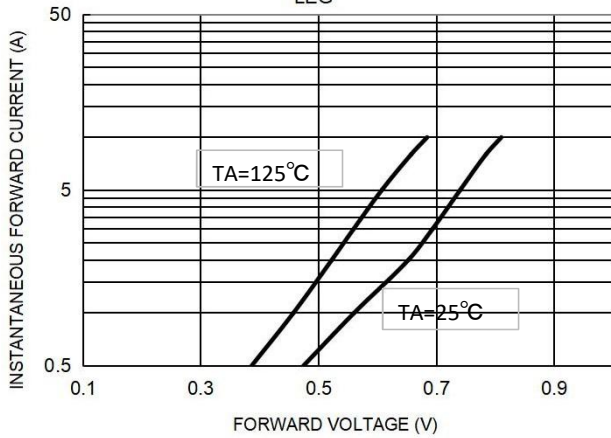
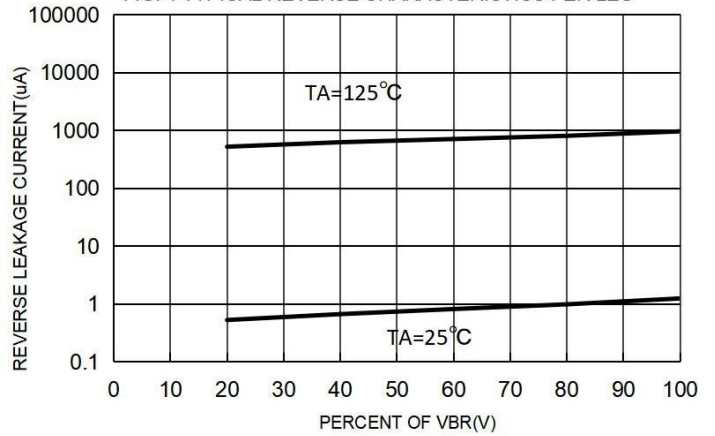
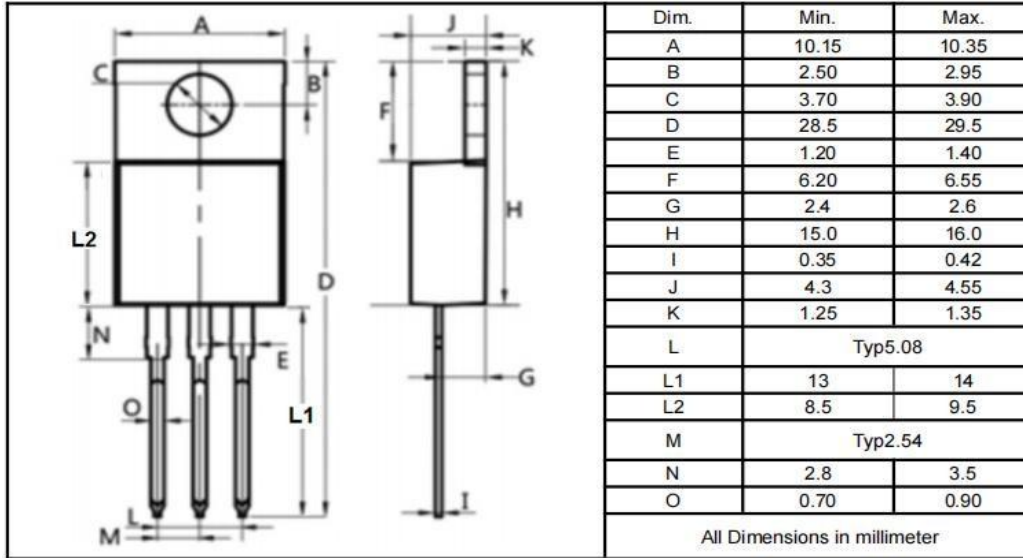


FIG. 4 TYPICAL REVERSE CHARACTERISTICS PER LEG



Package Outline Dimensions millimeters

TO-220AB

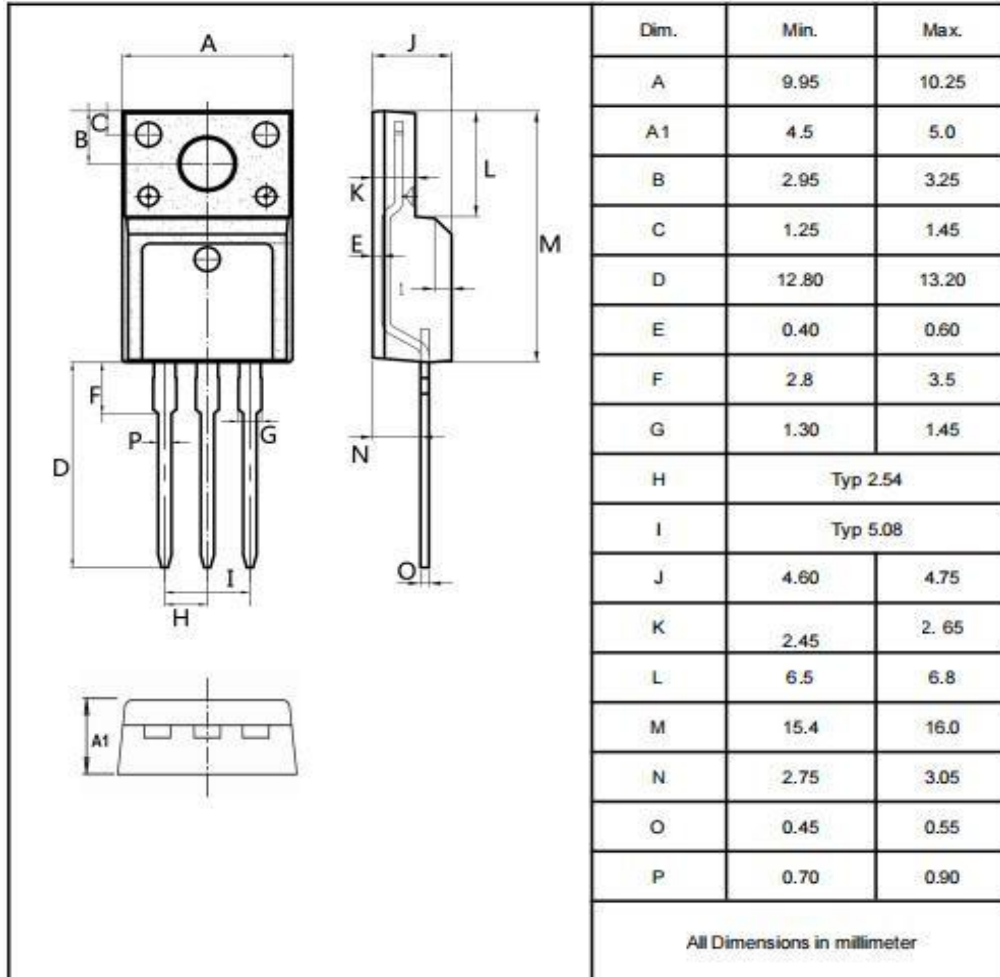


REEL SPECIFICATION

P/N	PKG	QTY
MBR20100CT-MS	TO-220AB	50pcs/tube 1000pcs/box

Package Outline Dimensions millimeters

TO-220F

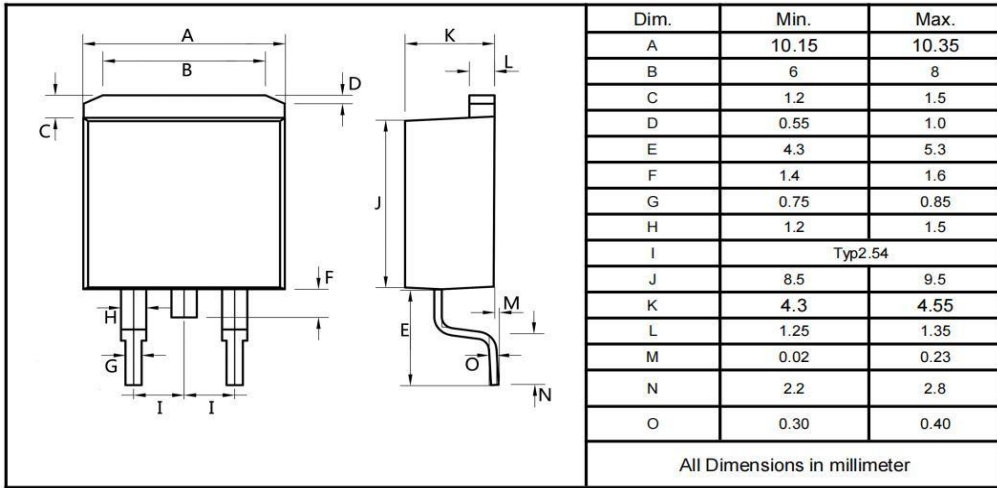


REEL SPECIFICATION

P/N	PKG	QTY
MBR20100FCT-MS	TO-220F	50pcs/tube 1000pcs/box

Package Outline Dimensions millimeters

TO-263



REEL SPECIFICATION

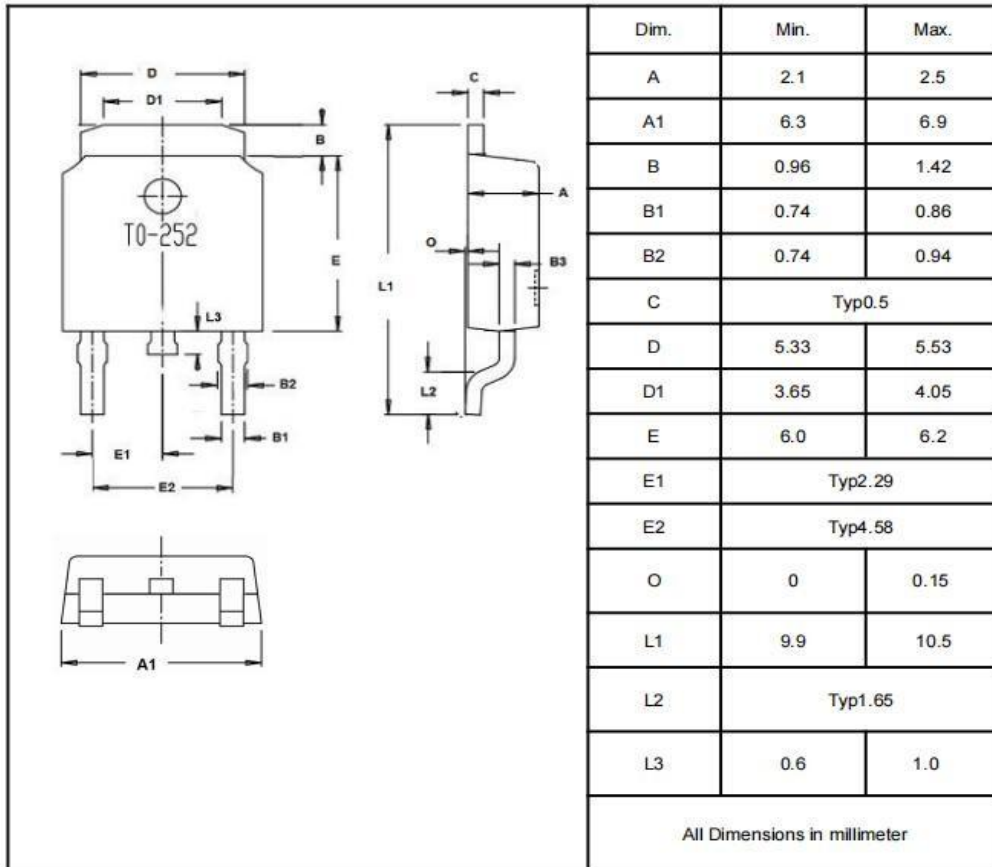
P/N	PKG	QTY
MBR20100DC-MS	TO-263	50pcs/tube 1000pcs/box

REEL SPECIFICATION

P/N	PKG	QTY
MBR20100DC-R-MS	TO-263	800pcs

Package Outline Dimensions millimeters

TO-252



REEL SPECIFICATION

P/N	PKG	QTY
MBR20100CS-MS	TO-252	2500

Attention

- Any and all MSKSEMI Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MSKSEMI Semiconductor representative nearest you before using any MSKSEMI Semiconductor products described or contained herein in such applications.
- MSKSEMI Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all MSKSEMI Semiconductor products described or contained herein.
- Specifications of any and all MSKSEMI Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- MSKSEMI Semiconductor strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all MSKSEMI Semiconductor products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of MSKSEMI Semiconductor.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. MSKSEMI Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringement of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the MSKSEMI Semiconductor product that you intend to use.

单击下面可查看定价，库存，交付和生命周期等信息

[>>MSKSEMI\(美森科\)](#)